

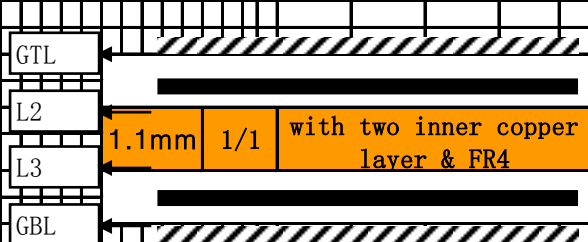
Elecrow 4-layer PCB layer stack for Green, blue, Red, Yellow PCB.
Black & white PCB excepted

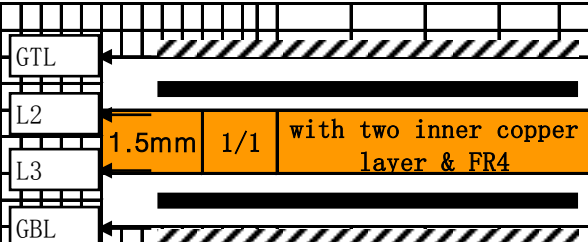
0.6	GTL		top layer	H	0.0175	mm	
	L2		bonding layer	2116	0.12	mm	
	L3		inner layer	with two inner copper layer & FR4	0.30	mm	
	GBL		bonding layer	2116	0.12	mm	
			bottom layer	H	0.0175	mm	
			lamination thickness		0.58	±0.10	mm
			4 layer PCB stack		Final PCB thickness	0.60	±0.10 mm

0.8	GTL		top layer	H	0.0175	mm	
	L2		bonding layer	2116	0.12	mm	
	L3		inner layer	with two inner copper layer & FR4	0.50	mm	
	GBL		bonding layer	2116	0.12	mm	
			bottom layer	H	0.0175	mm	
			lamination thickness		0.78	±0.10	mm
			4 layer PCB stack		Final PCB thickness	0.80	±0.10 mm

1.0	GTL		top layer	H	0.0175	mm	
	L2		PP胶:	7628	0.195	mm	
	L3		inner layer	with two inner copper layer & FR4	0.50	mm	
	GBL		PP胶:	7628	0.195	mm	
			bottom layer	H	0.0175	mm	
			lamination thickness		0.93	±0.10	mm
			4 layer PCB stack		Final PCB thickness	1.00	±0.10 mm

1.2	GTL		top layer	H	0.0175	mm	
	L2		bonding layer	7628	0.195	mm	
	L3		inner layer	with two inner copper layer & FR4	0.70	mm	
	GBL		bonding layer	7628	0.195	mm	
			bottom layer	H	0.0175	mm	
			lamination thickness		1.13	±0.10	mm
			4 layer PCB stack		Final PCB thickness	1.20	±0.10 mm

1.6				top layer	H	0.0175	mm
				bonding layer	7628	0.195	mm
				inner layer	with two inner copper layer & FR4	1.10	mm
				bonding layer	7628	0.195	mm
				bottom layer	H	0.0175	mm
	4 layer PCB stack			lamination thickness		1.53	±0.10 mm
				Final PCB thickness		1.60	±0.10 mm

2.0				top layer	H	0.0175	mm
				bonding layer	7628	0.195	mm
				inner layer	with two inner copper layer & FR4	1.50	mm
				bonding layer	7628	0.195	mm
				bottom layer	H	0.0175	mm
	4 layer PCB stack			lamination thickness		1.93	±0.10 mm
				Final PCB thickness		2.00	±0.10 mm